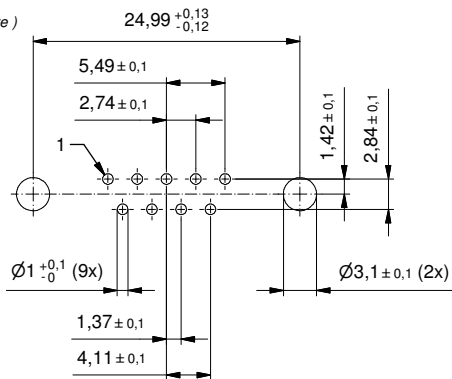


PCB hole drillings
(PCB top side) /
Leiterplattenbohrbild
(Leiterplatten Oberseite)



Technical specification:

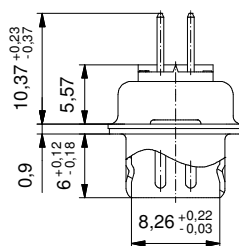
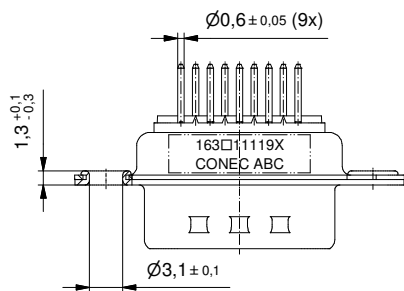
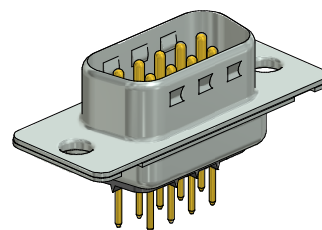
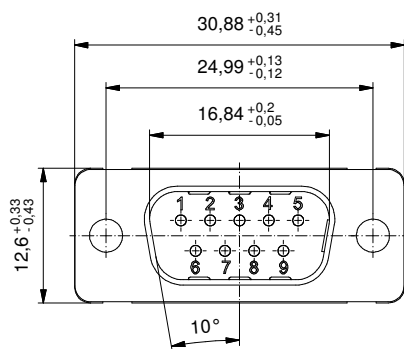
Technische Daten:

Working voltage/ Betriebsspannung:	125 V AC
Insulation resistance/ Isolationswiderstand:	≥5 GΩ
Dielectric withstanding voltage/ Spannungsfestigkeit:	1000 V, 50 Hz, 1 min.
Temperature range/ Temperaturbereich:	-55 °C ... +125 °C
Current rating/ Strombelastbarkeit:	7,5 A (UL) / 5 A (CSA, VDE)
Mating cycles/ Steckzyklen:	Quality class 1 = 500 Gütestufe 1 Quality class 2 = 200 Gütestufe 2 Quality class 3 = 50 Gütestufe 3

Materials/

Werkstoffe:

Contact/ Kontakt:	Cu alloy, Au over Ni
Insulator/ Isolierkörper:	PBT GF UL 94 V-0, black/schwarz
Shell/ Gehäuse:	Steel, Sn over Ni



(b)

Part no. / Part Marked/ Art.-Nr. / Bedruckung:	Contact plating/ Kontakt Veredelung:
163A11119X	Gold Flash over Nickel Gold über Nickel
163B11119X	20 µin Hard Gold over min. 50 µin Nickel 20 µin Gold über min. 50 µin Nickel
163C11119X	30 µin Hard Gold over min. 50 µin Nickel 30 µin Gold über min. 50 µin Nickel
dim. in mm	D-SUB Male 9pol.
	D-SUB Stiftleiste 9pos.
	dwg no / Z.-nr.:
	16K1A1705
Index: Ind. b Ä6267 10.08.16 K.H.	DIN-A3
Status: InBearbeitung	1 / 1
RoHS & REACH compliant/ konform	

CONEC